

AOT11N60L/AOTF11N60L/AOTF11N60

600V,11A N-Channel MOSFET

General Description

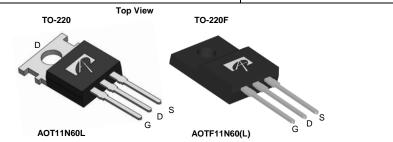
The AOT11N60L & AOTF11N60L & AOTF11N60 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular ACDC applications.By providing low $R_{\rm DS(on)},\,C_{\rm iss}$ and $C_{\rm rss}$ along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

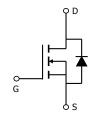
Product Summary

 $\begin{array}{ll} V_{DS} & 700V@150^{\circ}C \\ I_{D} \ (at \ V_{GS} = 10V) & 11A \\ R_{DS(ON)} \ (at \ V_{GS} = 10V) & < 0.65\Omega \end{array}$

100% UIS Tested 100% R_g Tested







		otherwise noted

Parameter		Symbol	AOT11N60L	AOTF11N60	AOTF11N60L	Units
Drain-Source Voltage		V_{DS}	600			V
Gate-Source Voltage		V_{GS}		V		
Continuous Drain	T _C =25°C		11	11*	11*	
Current	T _C =100°C	I _D	8	8*	8*	Α
Pulsed Drain Current ^C		I _{DM}				
Avalanche Current ^C		I _{AR}		Α		
Repetitive avalanche energy ^C		E _{AR}	345			mJ
Single plused avalanche energy ^G		E _{AS}	690			mJ
Peak diode recovery dv/dt		dv/dt	5			V/ns
	T _C =25°C	P_{D}	272	50	37.9	W
Power Dissipation ^B	Derate above 25°C	' D	2.2	0.4	0.3	W/ °C
Junction and Storage Temperature Range		T_J , T_{STG}	-55 to 150			°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds		T _L	300			°C

Thermal Characteristics

Parameter	Symbol	AOT11N60L	AOTF11N60	AOTF11N60L	Units
Maximum Junction-to-Ambient A,D	$R_{\theta JA}$	65	65	65	°C/W
Maximum Case-to-sink ^A	R _{ecs}	0.5			°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.46	2.5	3.3	°C/W

^{*} Drain current limited by maximum junction temperature.



Electrical Characteristics (T_{.1}=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC PARAMETERS							
BV _{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V, T_J = 25 ^{\circ}C$	600				
		I_D =250 μ A, V_{GS} =0V, T_J =150°C		700		V	
BV _{DSS} /ΔTJ	Breakdown Voltage Temperature Coefficient	I _D =250μA, V _{GS} =0V		0.67		V/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V			1	μА	
		V _{DS} =480V, T _J =125°C			10		
I _{GSS}	Gate-Body leakage current	V_{DS} =0V, V_{GS} =±30V			±100	nA	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} =5 $V I_D$ =250 μ A	3.3	3.9	4.5	V	
R _{DS(ON)}	Static Drain-Source On-Resistance	V_{GS} =10V, I_D =5.5A		0.56	0.65	Ω	
g _{FS}	Forward Transconductance	V _{DS} =40V, I _D =5.5A		12		S	
V _{SD}	Diode Forward Voltage	I _S =1A,V _{GS} =0V		0.73	1	V	
Is	Maximum Body-Diode Continuous Cu			11	Α		
I _{SM}	Maximum Body-Diode Pulsed Current				39	Α	
DYNAMIC	PARAMETERS		•	-	-		
C _{iss}	Input Capacitance		1320	1656	1990	pF	
Coss	Output Capacitance	V_{GS} =0V, V_{DS} =25V, f=1MHz	100	146	195	pF	
C _{rss}	Reverse Transfer Capacitance		6.5	11.2	16	pF	
R_g	Gate resistance	V_{GS} =0V, V_{DS} =0V, f=1MHz	1.7	3.5	5.3	Ω	
SWITCH	NG PARAMETERS						
Q_g	Total Gate Charge		24	30.6	37	nC	
Q_{gs}	Gate Source Charge	V_{GS} =10V, V_{DS} =480V, I_{D} =11A		9.6		nC	
Q_{gd}	Gate Drain Charge			9.6		nC	
t _{D(on)}	Turn-On DelayTime			39		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =300V, I_{D} =11A,		58		ns	
t _{D(off)}	Turn-Off DelayTime	$R_G=25\Omega$		92		ns	
t _f	Turn-Off Fall Time			42		ns	
t _{rr}	Body Diode Reverse Recovery Time	I _F =11A,dI/dt=100A/μs,V _{DS} =100V	400	500	600	ns	
Q _{rr}	Body Diode Reverse Recovery Charge	e I _F =11A,dI/dt=100A/μs,V _{DS} =100V	4.7	5.9	7.1	μС	

A. The value of R $_{\rm BJA}$ is measured with the device in a still air environment with T $_{\rm A}$ =25 $^{\circ}$ C.

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B. The power dissipation P_D is based on T_{J(MAX)}=150° C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$ =150° C, Ratings are based on low frequency and duty cycles to keep initial $T_J = 25^{\circ} C$.

D. The R _{BJA} is the sum of the thermal impedence from junction to case R _{BJC} and case to ambient.

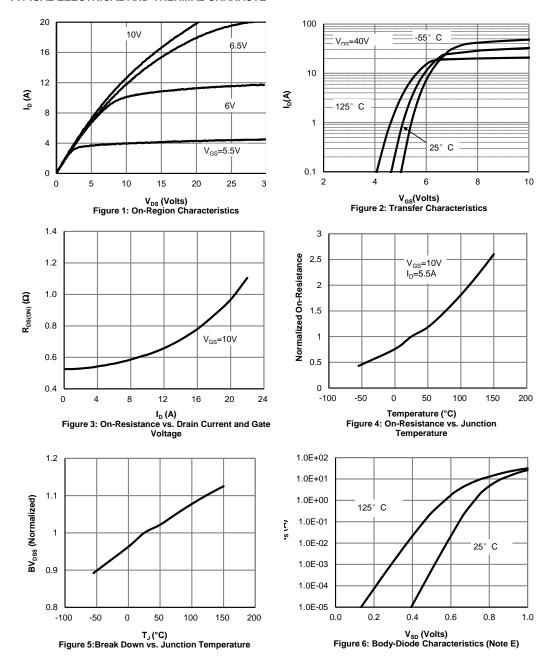
E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedence which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(MAX)}$ =150° C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=4.8A, V_DD=150V, R_G=25 ${\rm \Omega}$, Starting T_J=25 $^{\circ}$ C

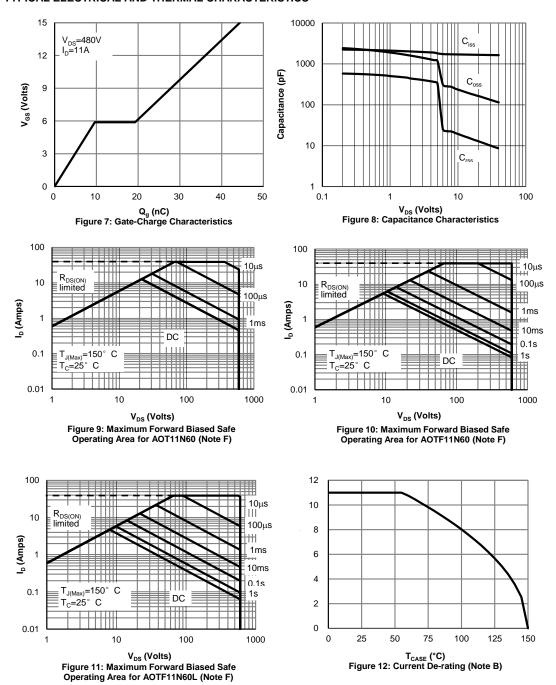


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



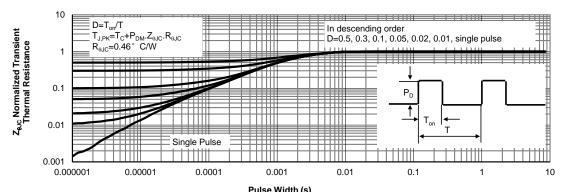


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

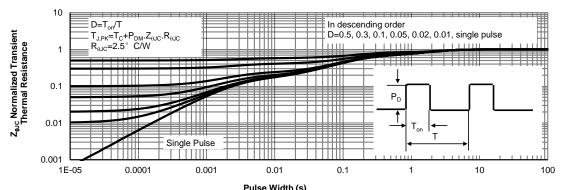




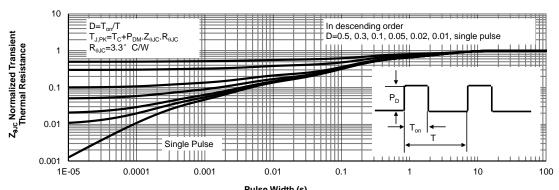
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



Pulse Width (s)
Figure 13: Normalized Maximum Transient Thermal Impedance for AOT11N60(Note F)



Pulse Width (s)
Figure 14: Normalized Maximum Transient Thermal Impedance for AOTF11N60 (Note F)

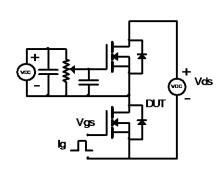


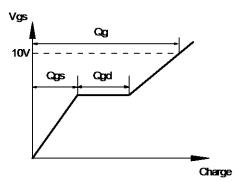
Pulse Width (s)
Figure 15: Normalized Maximum Transient Thermal Impedance for AOTF11N60L (Note F)

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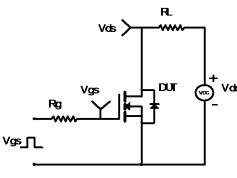


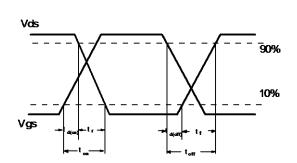
Gate Charge Test Circuit & Waveform



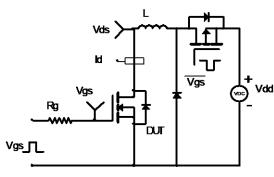


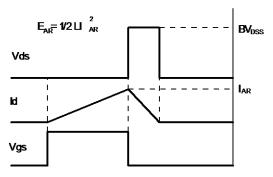
Resistive Switching Test Circuit & Waveforms



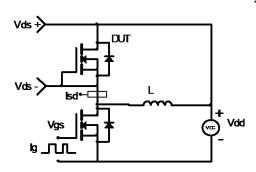


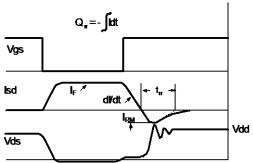
Unclamped Inductive Switching (UIS) Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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